

Surface Mount Fast Recovery Rectifiers
Reverse Voltage - 50 to 1000 V
Forward Current - 1 A
FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: SMBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 57mg / 0.002oz

Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode

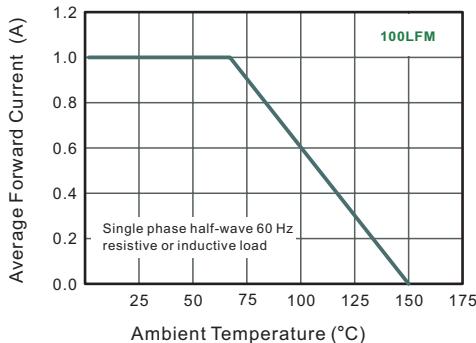
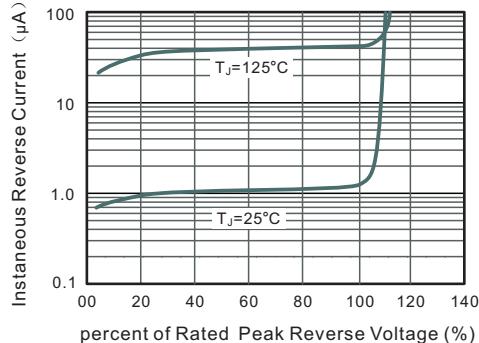
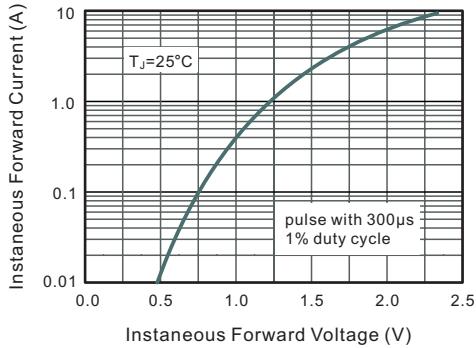
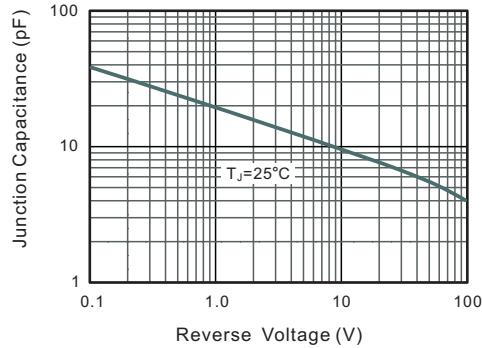
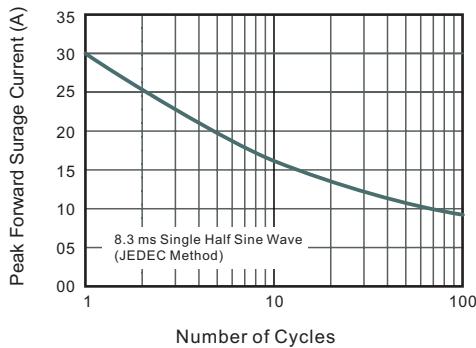

 Top View
 Marking Code: R1AB-R1MB
 Simplified outline SMBF symbol

Parameter	Symbols	RS1ABF	RS1BBF	RS1DBF	RS1GBF	RS1JBF	RS1KBF	RS1MBF	Units			
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V			
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V			
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V			
Maximum Average Forward Rectified Current at Ta = 65 °C	I _{F(AV)}	1							A			
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	30							A			
Maximum Instantaneous Forward Voltage at 1 A	V _F	1.3							V			
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta = 125 °C	I _R	5 50							µA			
Maximum Reverse Recovery Time ¹⁾	t _{rr}	150			250	500			ns			
Typical Junction Capacitance ²⁾	C _j	15							pF			
Typical Thermal Resistance ³⁾	R _{θJA}	85							°C/W			
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150							°C			

 1) Measured with I_F = 0.5 A, I_R = 1 A, I_{rr} = 0.25 A

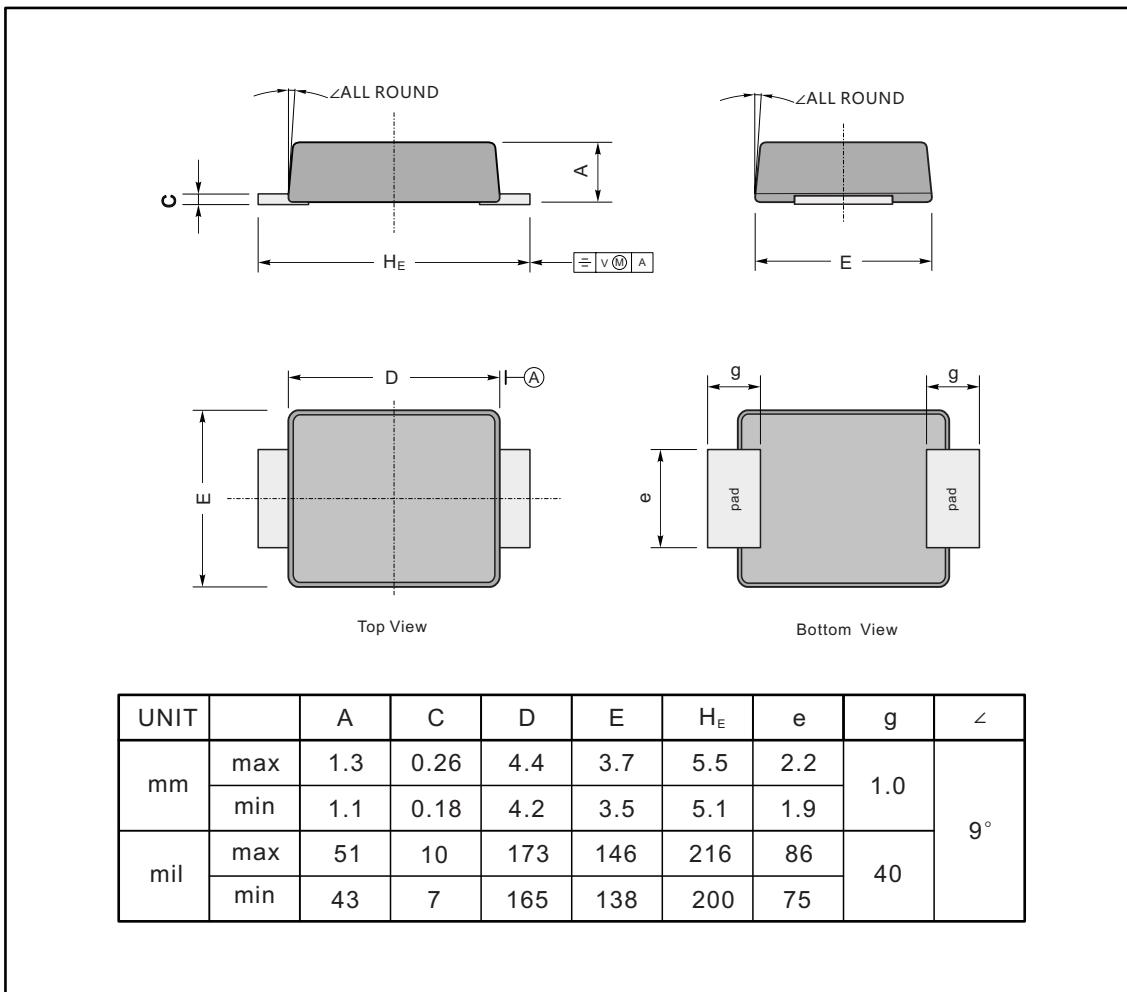
2) Measured at 1MHz and applied reverse voltage of 4V D.C

 3) P.C.B. mounted with 0.5 X 0.5" (12.7 X 12.7 mm²) copper pad areas.

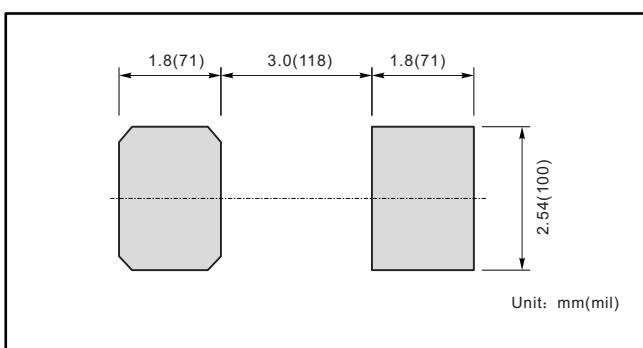
Fig.1 Forward Current Derating Curve

Fig.2 Typical Reverse Characteristics

Fig.3 Typical Instantaneous Forward Characteristics

Fig.4 Typical Junction Capacitance

Fig.6 Maximum Non-Repetitive Peak Forward Surge Current


PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMBF


The recommended mounting pad size



Marking

Type number	Marking code
RS1ABF	R1AB
RS1BBF	R1BB
RS1DBF	R1DB
RS1GBF	R1GB
RS1JBF	R1JB
RS1KBF	R1KB
RS1MBF	R1MB